## TOSHIBA PHOTOINTERRUPTER INFRARED LED + PHOTO IC

# **TLP1024**

PRINTER, ELECTRONIC TYPEWRITER, FACSIMILE COPYING MACHINE, LATHER BEAMING PRINTER VCR, VIDEODISC, COMPACT DISC VARIOUS POSITION DETECTION

TLP1024 is a digital output photointerrupter with a GaAs infrared LED and a high sensitive and high gain Si photo IC combined.

This photointerrupter has a response speed faster than the phototransistor output and is capable of high speed position detection.

Further because of large output current and a built-in Schmitt trigger circuit, this photointerrupter is connectable directly to a microcomputer or logic IC.

Its output becomes low level when the light is shielded. The TLP1034 with a pull-up resistor in the same shape as this photointerrupter is also available.

Side mounting type

: 3mm Gap

Resolution : Slit width 0.5mm

Digital output (open collector)

Digital connectable to TTL, LSTTL and CMOS.

Threshold input current : I<sub>FLH</sub>=4mA (Max.) at

 $Ta = 25^{\circ}C$ 

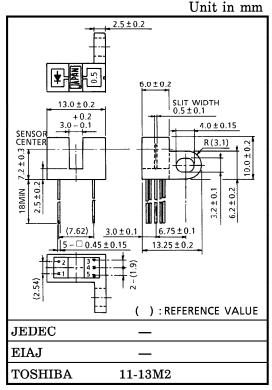
Operating supply voltage : V<sub>CC</sub>=4.5~17V

Built-in Schmitt trigger circuit

:  $tpLH = 3\mu s$ ,  $tpHL = 6\mu s$ Fast response speed

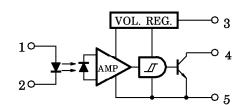
(Typ.)

Detector side is of visible light cut type.



Weight: 0.87g (Typ.)

#### PIN CONNECTION



- 1. ANODE
- 2. CATHODE
- 3. VCC
- 4. OUT
- 5. GND

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- TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

  Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

  The products described in this document are subject to foreign exchange and foreign trade control laws.

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# MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT		
LED	Forward Current	$I_{\mathbf{F}}$	50	mA		
	Forward Current Derating (Ta>25°C)	$\Delta I_{\mathbf{F}} / {^{\circ}\mathbf{C}}$	-0.33	mA/°C		
	Reverse Voltage	$v_{ m R}$	5	V		
	Supply Voltage	$v_{CC}$	17	V		
)R	Output Voltage	$v_{O}$	30	V		
TC	Output Current	IO	50	mA		
DETECTOR	Power Dissipation	PO	250	mW		
DE.	Power Dissipation Derating (Ta>25°C)	△PO/°C	-3.33	mW/°C		
Operating Temperature Range		${ m T_{opr}}$	-25~85	°C		
Storage Temperature Range		$\mathrm{T_{stg}}$	-40~100	°C		
So	ldering Temperature (5s)	$T_{ m sol}$	260	°C		

# RECOMMENDED OPERATING CONDITIONS

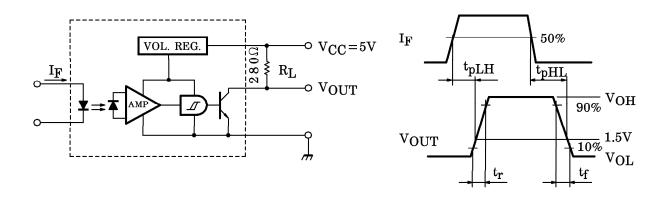
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
LED Forward Current	${ m I_F}$	14*	_	20	mA
Supply Voltage	$v_{CC}$	4.5	5	17	V
Output Voltage	$v_{O}$	1	5	24	V
Low Level Output Current	$I_{ m OL}$	1	_	16	mA
Operating Temperature	$T_{ m opr}$	-25	_	85	°C

<sup>\* 14</sup>mA is a value when 50% LED deterioration is taken into consideration. Initial threshold input current shall be 7mA MAX.

OPTO-ELECTRICAL CHARACTERISTICS (Unless Otherwise Specified,  $Ta = -25 \sim 85$ °C,  $V_{CC} = 4.5 \sim 5.5$ V)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
LED	Forward Current	$ m V_{ m F}$	I <sub>F</sub> =10mA, Ta=25°C		1.15	1.30	V	
	Reverse Current I <sub>R</sub>		$V_R=5V$ , $T_a=25$ °C	_	_	10	$\mu$ A	
	Peak Emission Wavelength	$\lambda_{\mathbf{P}}$	I <sub>F</sub> =25mA, Ta=25°C	_	940	_	nm	
	Supply Voltage	$v_{CC}$	_	4.5	_	17	V	
DETECTOR	Low Level Supply Curre	ent Iggs	$I_{\mathbf{F}} = 0$	_	_	5.0	mA	
	Low Level Supply Cull	ent I <sub>CCL</sub>	$I_F=0, V_{CC}=17V$		_	5.2		
	High Level Supply	$_{ m I_{CCH}}$	I <sub>E</sub> =15mA	_	_	3.0	mA	
	Current	1CCH	I <sub>F</sub> =15mA, V <sub>CC</sub> =17V	_	_	3.2		
	Low Level Output Volta	go Vor	$I_{OL}$ =16mA, $I_{F}$ =0 Ta=25°C	_	0.07	0.3	$\left \begin{array}{c} v \end{array}\right $	
	Low Level Output voits	ge V <sub>OL</sub>	I <sub>OL</sub> =16mA, I <sub>F</sub> =0 V <sub>CC</sub> =17V	_	_	0.4	v	
	High Level Output Current	IOH	I <sub>F</sub> =15mA, V <sub>O</sub> =30V	_	_	15	$\mu$ A	
	Peak Sensitivity Wavelength	$\lambda_{\mathbf{P}}$	Ta=25°C		900	_	nm	
	Threshold Input Curren	I <sub>FLH</sub>	Ta=25°C		_	4	mA	
COUPLED	(L→H)	*FLH	$V_{CC} = 17V$		_	7	ША	
	Hysteresis Ratio	I <sub>FHL</sub> /I <sub>FLH</sub>	Ta=25°C	<u> </u>	0.67	_		
	Propagation L→1	I t <sub>pLH</sub>		_	3	_		
	Delay Time H→	t <sub>pHL</sub>	$V_{\rm CC}$ =5V, I <sub>F</sub> =15mA	_	6	_	μs	
	Rise Time	t <sub>r</sub>	$R_L = 280\Omega$ , $T_a = 25$ °C (Note)	_	0.1	_		
	Fall Time	$t_f$		_	0.05	_		

NOTE: SWITCHING TIME TEST CIRCUIT



#### **PRECAUTION**

Please be careful of the followings.

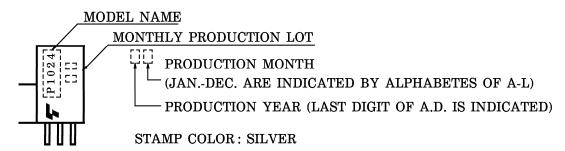
- 1. Soldering should be performed after lead forming.
- 2. If chemicals are used for cleaning, the soldered surface only shall be cleaned with chemicals avoiding the whole cleaning of the package.
- 3. The container is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol, and aliphatic hydrocarbons however, with pertochemicals (such as benzene, toluene, and acetone), alkali, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate becomes cracked, swollen, or melted. Please take care when chosing a packaging material by referencing the table below.

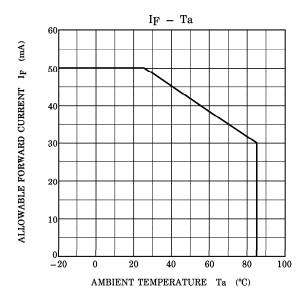
#### <Chemicals to avoid with polycarbonate>

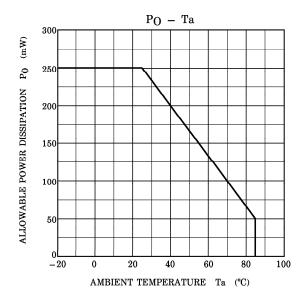
	PHENOMENON	CHEMICALS	
Α	Little deterioration but staining	• nitric acid (low concentration), hydrogen peroxide, chlorine	
В	Cracked, crazed, or swollen	<ul> <li>acetic acid (70% or more)</li> <li>gasoline</li> <li>methyl ethyl ketone, ehtyl acetate, butyl acetate</li> <li>ethyl methacrylate, ethyl ether, MEK</li> <li>acetone, m-amino alcohol, carbon tetrachloride</li> <li>carbon disulfide, trichloroethylene, cresol</li> <li>thinners, oil of turpentine</li> <li>triethanolamine, TCP, TBP</li> </ul>	
С	Melted { }: Used as solvent.	<ul> <li>concentrated sulfuric acid</li> <li>benzene</li> <li>styrene, acrylonitrile, vinyl acetate</li> <li>ethylenediamine, diethylenediamine</li> <li>chloroform, methyl chloride, tetrachloromethane, dioxane</li> <li>1, 2-dichloroethane</li> </ul>	
D	Decomposed	ammonia water     other alkali	

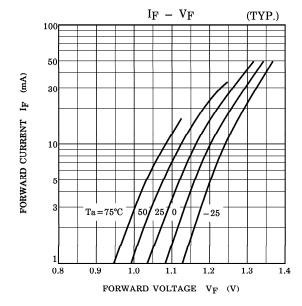
- 4. During  $100\mu$ s after turning on VCC, output voltage changes for stabilizing the inner circuit.
- 5. Supply the by-pass condenser up to  $0.01\mu\mathrm{F}$  betweeen VCC and GND near device to stabilize the power supply line.
- 6. Screw shall be tightened to clamping torque of 0.59N·m.

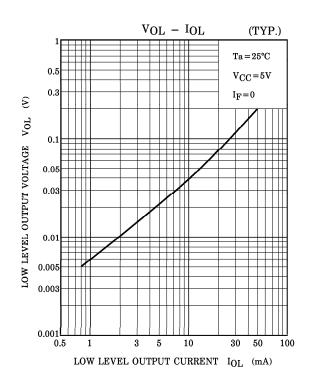
## PRODUCT INDICATION

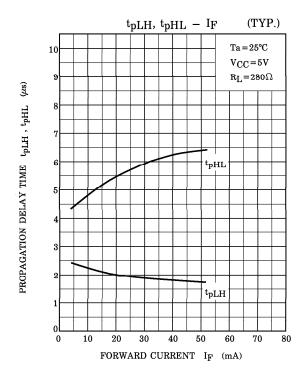


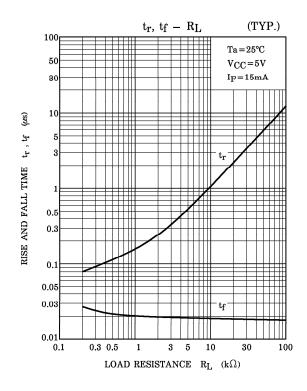


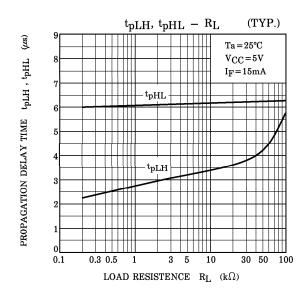


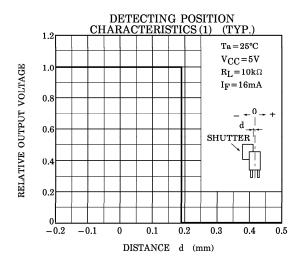


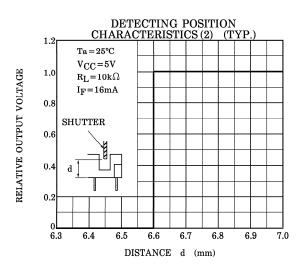








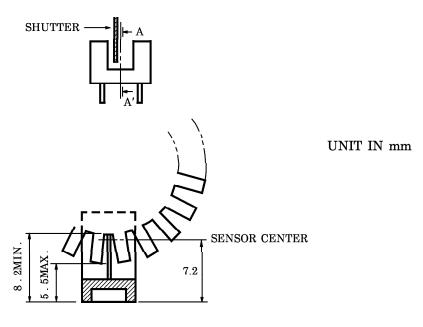




## POSITIONING OF SHUTTER AND DEVICE

To operate correctly, make sure that the shutter and the device are positioned as shown in the figure below.

The shit pitch of the shutter must be set wider than the slit width of the device. Determine the width taking the switching time into consideration.



A-A' CROSS SECTION